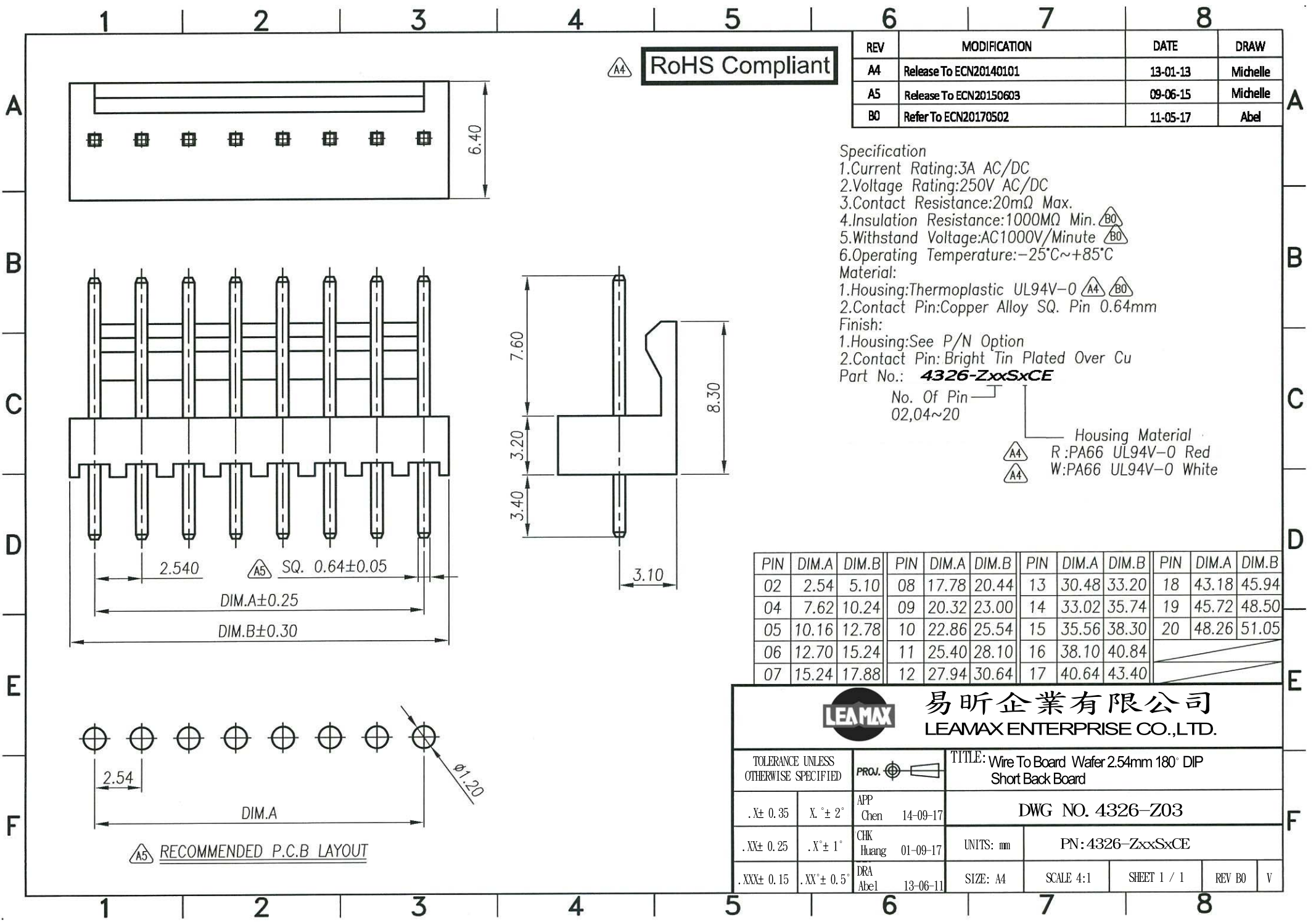




易昕企業有限公司
LEAMAX ENTERPRISE CO.,LTD.

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROV.	TITLE: Wire To Board Wafer 2.54mm 180° DIP Short Back Board			
.X± 0.35	X. ° ± 2°	APP Chen 14-09-17	DWG NO. 4326-Z03			
.XX± 0.25	.X° ± 1°	CHK Huang 01-09-17	UNITS: mm	PN: 4326-ZxxSxCE		
.XXX± 0.15	.XX° ± 0.5°	DRA Abel 13-06-11	SIZE: A4	SCALE 4:1	SHEET 1 / 1	REV B0 V